layer is an AlN layer.

17. (Amended) The method as claimed in claim 11, wherein said metal layer is a boron layer.

18. (Amended) The method as claimed in claim 17, wherein said metallic nitride layer is a BN layer.

19. (Amended) The method as claimed in claim 11, wherein said metal layer is a gallium layer.

20. (Amended) The method as claimed in claim 19, wherein said metallic nitride layer is a GaN layer.

REMARKS

The Applicant is in receipt of the Restriction requirement dated December 11, 2002. Upon review of the claims, it was discovered that claims 14-20, which depended from method claim 11, should have originally be considered as dependent "method" claims. Accordingly, the Applicant is hereby introducing this amendment to properly identify claims 14-20 as method claims, and hereby elects claims 11-20 and 21-23, belonging to group II (method group), to prosecute in this application.

Should the Examiner have any questions concerning this matter, the undersigned can be reached at the telephone number set out below.

> Respectfully submitted, MARTINE & PENILLA, LLP

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PATENT



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the application of:)
	Examiner: Louie, Wai Sing
Jen-Inn Chyi	
•	Group Art Unit: 2814
Application No: 10/039,199)
	Date: January 13, 2003
Filed: January 4, 2002	JAN 22 JAN 22 TECHNOLOGY
) 著しる
For: BUFFER LAYER OF LIGHT	5 %
EMITTING SEMICONDUCTOR DEVICE	22
AND METHOD OF FABRICATING THE) 233
SAME	2 2003 CENTER 2800
	FR 3
	28
	00

Marked Up Claims

- 14. (Amended) The [buffer layer] method as claimed in claim 13, wherein said metallic nitride layer is an InN layer.
- 15. (Amended) The [buffer layer] method as claimed in claim 11, wherein said metal layer is an aluminum layer.
- 16. (Amended) The [buffer layer] method as claimed in claim 15, wherein said metallic nitride layer is an AlN layer.
- 17. (Amended) The [buffer layer] method as claimed in claim 11, wherein said metal layer is a boron layer.
- 18. (Amended) The [buffer layer] method as claimed in claim 17, wherein said metallic nitride layer is a BN layer.
- 19. (Amended) The [buffer layer] method as claimed in claim 11, wherein said metal layer is a gallium layer.
- 20. (Amended) The [buffer layer] method as claimed in claim 19, wherein said metallic nitride layer is a GaN layer.

Attorney Docket No: JLINP055